

# 200V Half-Bridge Driver

## PRODUCT SUMMARY

- $V_{OFFSET}$  200 V max.
- $I_{O+/-}$  1A/1.5A
- $V_{OUT}$  10 V - 18 V
- $t_{on/off}$  (typ.) 150 ns/150 ns
- Deadtime (typ.) 110 ns

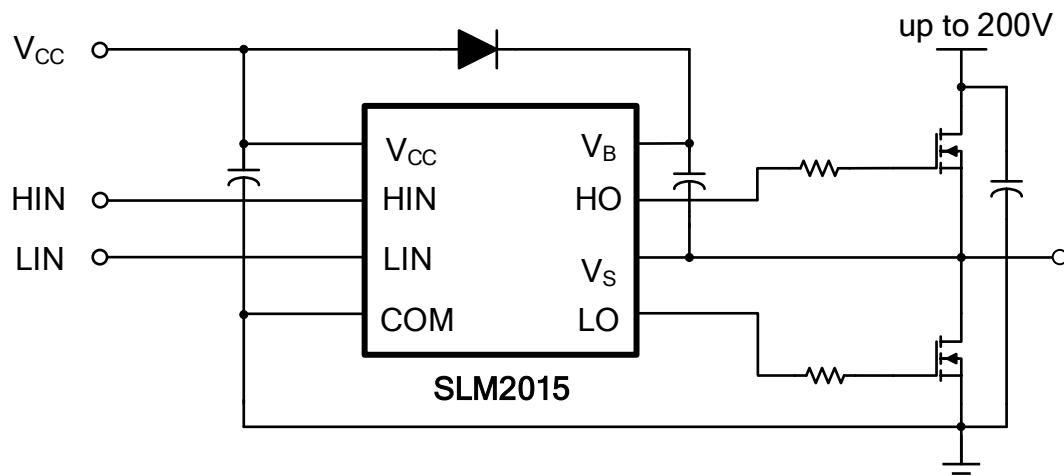
## GENERAL DESCRIPTION

The SLM2015 is a high voltage, high speed power MOSFET and IGBT drivers with dependent high- and low-side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3 V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross conduction. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high-side configuration which operates up to 200 V.

## FEATURES

- Floating channel designed for bootstrap operation
- Fully operational to +200 V
- Tolerant to negative transient voltage, dV/dt immune
- Gate drive supply range from 10 V to 18 V
- Undervoltage lockout
- 3.3 V, 5 V logic compatible
- Cross-conduction prevention logic
- Matched propagation delay for both channels
- Internal set deadtime
- High-side/Low-side output in phase with HIN/LIN input
- RoHS compliant
- SOP8 package

## TYPICAL APPLICATION CIRCUIT



(Refer to Pin Configuration for correct configuration. This diagram shows electrical connections only.)

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## PIN CONFIGURATION

Package	Pin Configuration (Top View)
SOP8	<p>The diagram shows a top-down view of an SOP8 package. Pin 1 (V<sub>CC</sub>) is at the top left, Pin 8 (V<sub>B</sub>) is at the top right, Pin 2 (H IN) is second from the top left, Pin 7 (HO) is second from the top right, Pin 3 (LIN) is third from the top left, Pin 6 (V<sub>S</sub>) is third from the top right, Pin 4 (COM) is fourth from the top left, and Pin 5 (LO) is fourth from the top right. A central vertical line labeled 'COM' connects pins 4 and 5.</p>

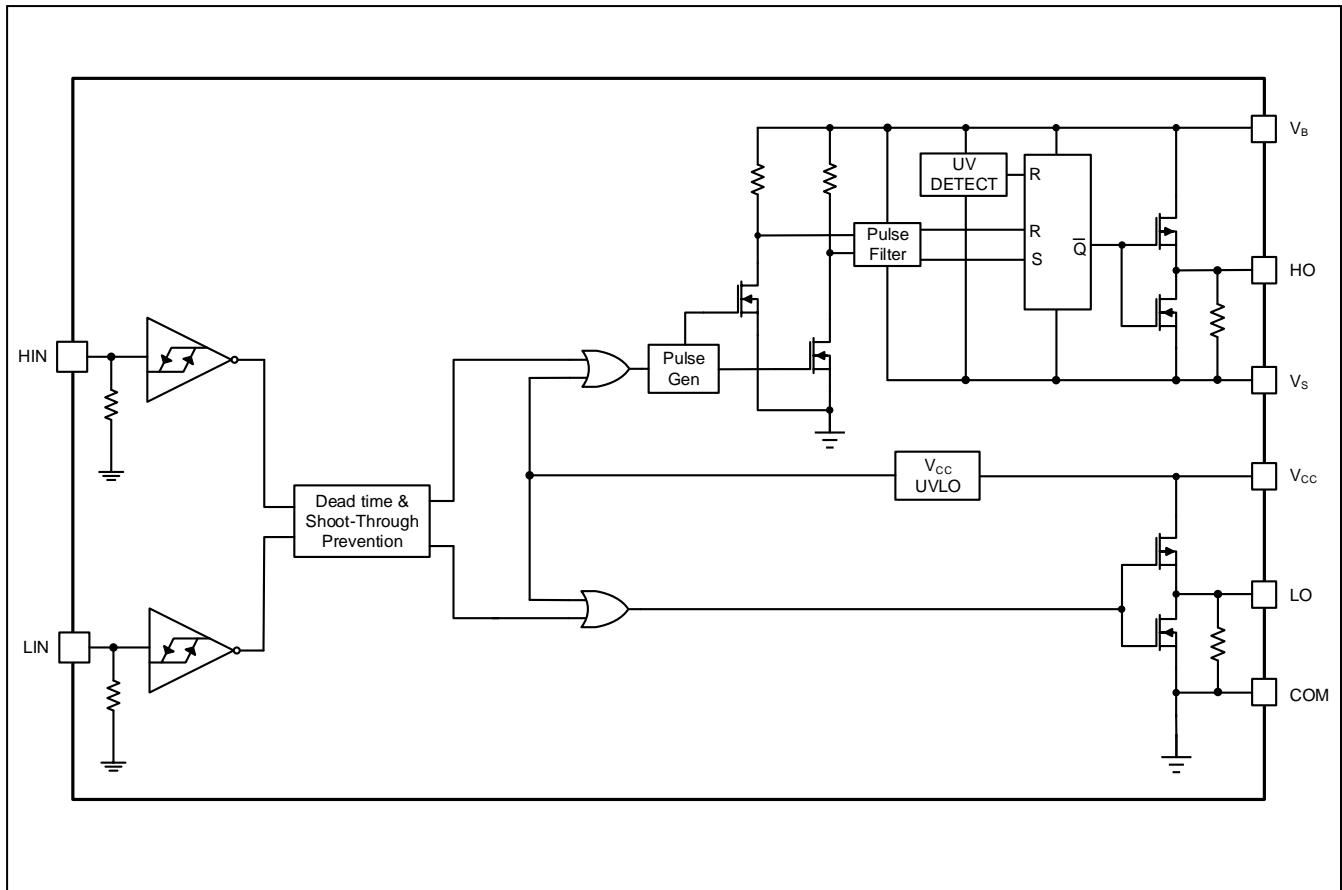
## PIN DESCRIPTION

No.	Pin	Description
1	V <sub>CC</sub>	Low-side and logic fixed supply
2	H IN	Logic input for high-side gate driver output (HO), in phase
3	LIN	Logic input for low-side gate driver output (LO), in phase
4	COM	Low-side return
5	LO	Low-side gate drive output
6	V <sub>S</sub>	High-side floating supply return
7	HO	High-side gate drive output
8	V <sub>B</sub>	High-side floating supply

## ORDERING INFORMATION

Order Part No.	Package	QTY
SLM2015CA-DG	SOP8, Pb-Free	2500/Reel

## FUNCTIONAL BLOCK DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

Symbol	Definition	Min.	Max.	Units
$V_B$	High-side floating absolute voltage	-0.3	220	V
$V_s$	High-side floating supply offset voltage	$V_B - 20$	$V_B + 0.3$	
$V_{HO}$	High-side floating output voltage	$V_s - 0.3$	$V_B + 0.3$	
$V_{CC}$	Low-side and logic fixed supply voltage	-0.3	20	
$V_{LO}$	Low-side output voltage	-0.3	$V_{CC} + 0.3$	
$V_{IN}$	Logic input voltage (HIN & LIN)	-0.3	10	
$dV_s/dt$	Allowable offset supply voltage transient	---	50	V/ns
$P_D$	Package power dissipation at $T_A \leq +25^\circ C$	---	0.625	W
$\theta_{JA}$	Thermal resistance, junction to ambient	---	200	$^\circ C/W$
$T_J$	Junction temperature	-40	150	$^\circ C$
$T_S$	Storage temperature	-55	150	
$T_L$	Lead temperature (soldering, 10 seconds)	---	300	

Note: Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

## RECOMMENDED OPERATION CONDITIONS

Symbol	Definition	Min.	Max.	Units
$V_B$	High-side floating absolute voltage	$V_s + 10$	$V_s + 18$	V
$V_s$	High-side floating supply offset voltage	0	200	
$V_{HO}$	High-side floating output voltage	$V_s$	$V_B$	
$V_{CC}$	Low-side and logic fixed supply voltage	10	18	
$V_{LO}$	Low-side output voltage	0	$V_{CC}$	
$V_{IN}$	Logic input voltage (HIN & LIN)	0	10	
$T_A$	Ambient temperature	-40	125	$^\circ C$

Note: For proper operation the device should be used within the recommended conditions. The  $V_s$  offset rating is tested with all supplies biased at a 15 V differential.

## DYNAMIC ELECTRICAL CHARACTERISTICS

$V_{BIAS}$  ( $V_{CC}$ ,  $V_{BS}$ ) = 15 V,  $C_L = 1000 \text{ pF}$  and  $T_A = 25^\circ\text{C}$  unless otherwise specified.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
$t_{on}$	Turn-on propagation delay	$V_S = 0 \text{ V}$	---	150	260	ns
$t_{off}$	Turn-off propagation delay	$V_S = 0 \text{ V}$	---	150	260	
$t_r$	Turn-on rise time		---	25	50	
$t_f$	Turn-off fall time		---	10	25	
DT	Deadtime, LS turn-off to HS turn-on & HS turn-on to LS turn-off		50	110	220	
MT	Delay matching, HS & LS turn-on/off		---	---	60	

Note: See timing diagram in Figure 1, Figure 2, Figure 3 and Figure 4

## STATIC ELECTRICAL CHARACTERISTICS

$V_{BIAS}$  ( $V_{CC}$ ,  $V_{BS}$ ) = 15 V and  $T_A = 25^\circ\text{C}$  unless otherwise specified. The  $V_{IN}$ ,  $V_{TH}$ , and  $I_{IN}$  parameters are referenced to COM. The  $V_O$  and  $I_O$  parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
$V_{IH}$	Logic "1" (HIN/LIN) input voltage	$V_{CC} = 10 \text{ V to } 18 \text{ V}$	2.5	---	---	V
$V_{IL}$	Logic "0" (HIN/LIN) input voltage		---	---	0.8	
$V_{OH}$	High level output voltage, $V_{BIAS} - V_O$	$I_O = 20 \text{ mA}$	---	0.16	0.3	
$V_{OL}$	Low level output voltage, $V_O$		---	0.07	0.15	
$I_{LK}$	Offset supply leakage current	$V_B = V_S = 200 \text{ V}$	---	---	50	$\mu\text{A}$
$I_{QBS}$	Quiescent $V_{BS}$ supply current	$V_O = 0 \text{ V}$	---	67	80	
$I_{QCC}$	Quiescent $V_{CC}$ supply current		---	230	300	
$I_{IN+}$	Logic "1" input bias current on HIN/LIN	$V_{IN} = 5 \text{ V}$	---	100	150	
$I_{IN-}$	Logic "0" input bias current on HIN/LIN	$V_{IN} = 0 \text{ V}$	---	---	5	
$V_{CCUV+}$	$V_{CC}$ supply undervoltage positive going threshold		8	8.8	9.8	V
$V_{CCUV-}$	$V_{CC}$ supply undervoltage negative going threshold		7.4	8.3	9	
$V_{BSUV+}$	$V_{BS}$ supply under-voltage positive going threshold			4.8		

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
$V_{BSUV}$	$V_{BS}$ supply under-voltage negative going threshold			4.3		V
$I_{O+}$	Output high short circuit pulsed current	$V_o = 0 \text{ V}, V_{IN} = V_{IH}$ $PW \leq 10 \mu\text{s}$		1		A
$I_{O-}$	Output low short circuit pulsed current	$V_o = 15 \text{ V}, V_{IN} = V_{IL}$ $PW \leq 10 \mu\text{s}$		1.5		

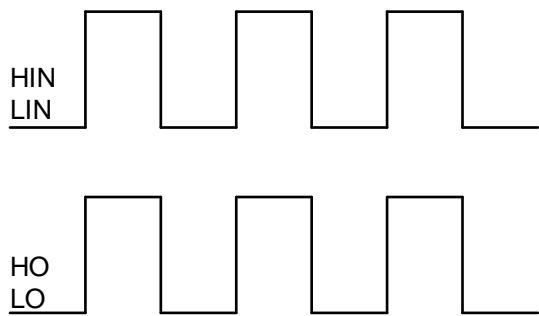


Figure 1. Input/Output Timing Diagram

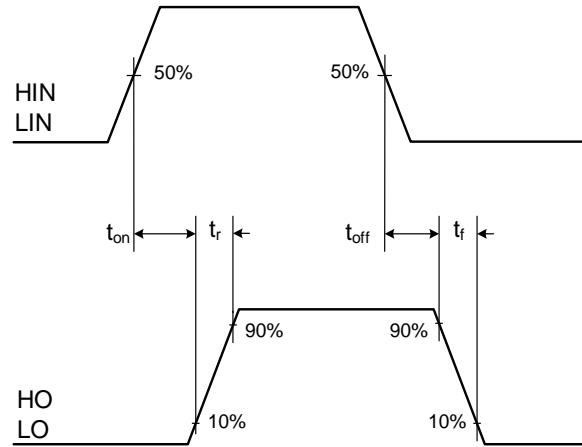


Figure 2. Switching Time Waveform

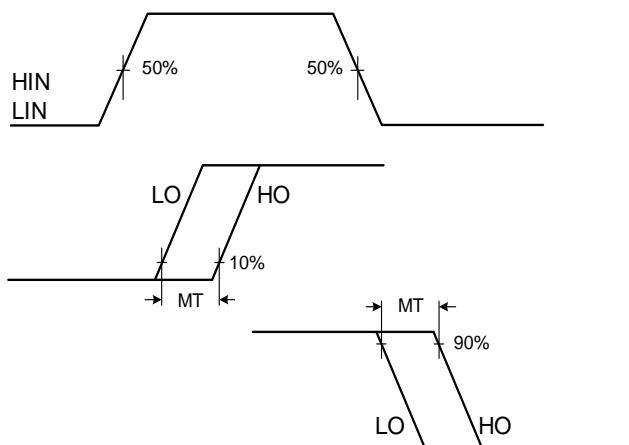


Figure 3. Delay Matching Waveform

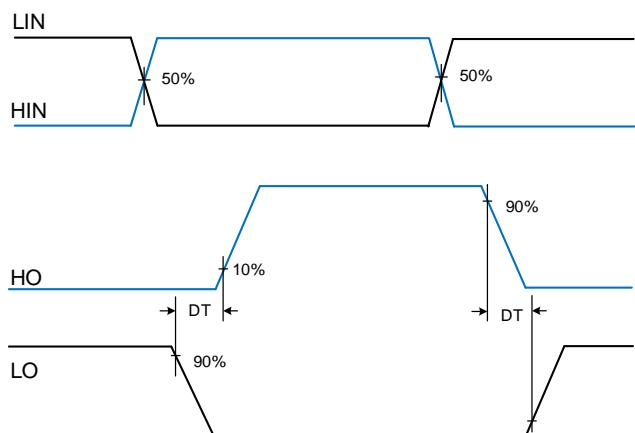


Figure 4. Deadtime Waveform

## PACKAGE CASE OUTLINES

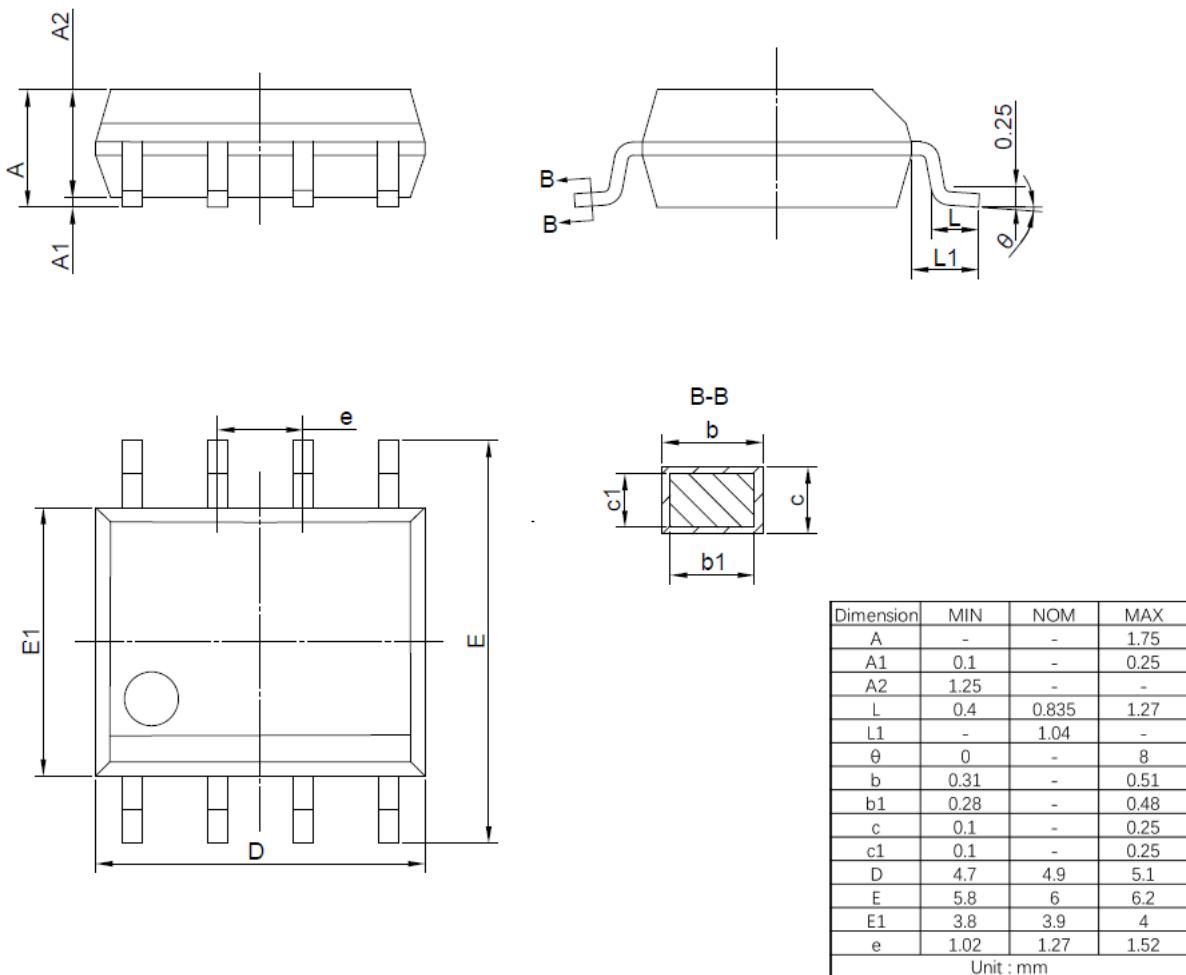


Figure 5. SOP8 Outline Dimensions

## REVISION HISTORY

Note: page numbers for previous revisions may differ from page numbers in current version.

Page or Item	Subjects (major changes since previous revision)
<b>Rev 0.1 preliminary datasheet 2021-08-06</b>	
Whole document	Rev 0.1 Preliminary datasheet release
<b>Rev 1.0 datasheet 2022-05-16</b>	
Whole document	Rev 1.0 datasheet release
<b>Rev 1.1 Datasheet, 2022-12-29</b>	
Page 8	SOP8 Outline Dimensions Update
<b>Rev 1.2 Datasheet, 2023-07-25</b>	
Page 3	Update the quantity per reel from 4000 to 2500 in Ordering Information table
Page 1, 5	Update the operation voltage to 200V Update the high-side floating absolute voltage ( $V_B$ ) max value to 220V in the Absolute Maximum Ratings table
Page 8	SOP8 Outline Dimensions Update: add the min and max value of D, E, E1 and e